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### **SDI Review Form 1.6**

Journal Name:	Journal of Engineering Research and Reports
Manuscript Number:	Ms_JERR_65046
Title of the Manuscript:	Die Crack Resolution Through Pick-up Process Optimization for BGA Package
Type of the Article	Original Research Article

### **General guideline for Peer Review process:**

This journal's peer review policy states that <u>NO</u> manuscript should be rejected only on the basis of '<u>lack of Novelty'</u>, provided the manuscript is scientifically robust and technically sound. To know the complete guideline for Peer Review process, reviewers are requested to visit this link:

(http://www.sciencedomain.org/journal/10/editorial-policy)

### **PART 1:** Review Comments

	Reviewer's comment	Author's comment (if agreed with reviewer, correct the manuscript and
		highlight that part in the manuscript. It is mandatory that authors should write his/her feedback here)
<u>Compulsory</u> REVISION comments		
Minor REVISION comments		
INTERIOR COMMENTS	In this work, the authors demonstrated the improvement is done in ball grid array (BGA) substrate package assembly to address the quantity of rejection of die crack during die picking at the die attach process station. However, the manuscript is interesting and appears suitable for publication in the Journal of Engineering Research and Reports after making the corrections noted below.  1- There are many spelling and punctuation errors, and a large part of them has been indicated in the body of the article as a note, please review it with high accuracy. Also, removing the extra space for the lines with yellow highlighted  2- In the introduction section, previous studies in the concerned field must be added with an indication of the pitfalls in those studies so that the author's work appears more prominent.  3- It would have been better if a special part including mechanical tests had been added to the prepared samples.  4- If it is possible to use semiconductors of a type other than silicon and compare them with the results obtained.  5- Figures 1, 4b, and 5 need to be clearer.  6- References must be formatted with one form, in addition to the necessity to make them recent.  7- Increasing the number of references to be at least 25 references	
Optional/General comments		

Created by: EA Checked by: ME Approved by: CEO Version: 1.6 (10-04-2018)

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## PART 2:

		Author's comment (if agreed with reviewer, correct the manuscript and highlight that part in the manuscript. It is mandatory that authors should write his/her feedback here)
Are there ethical issues in this manuscript?	(If yes, Kindly please write down the ethical issues here in details)	

### **Reviewer Details:**

Name:	Jamal M. Rzaij
Department, University & Country	University of Anbar, Iraq

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